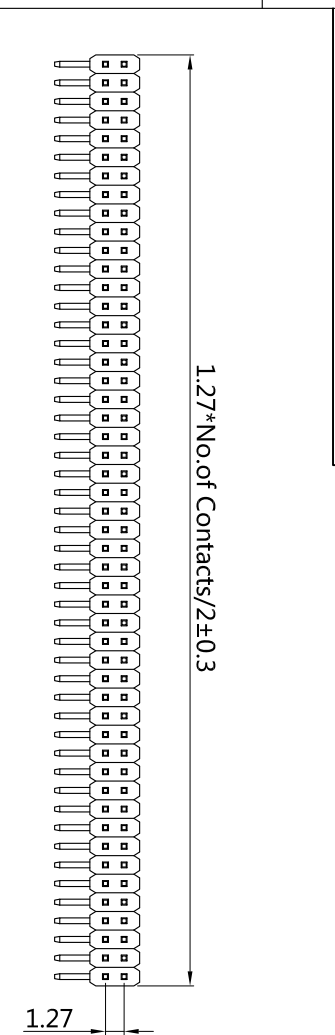
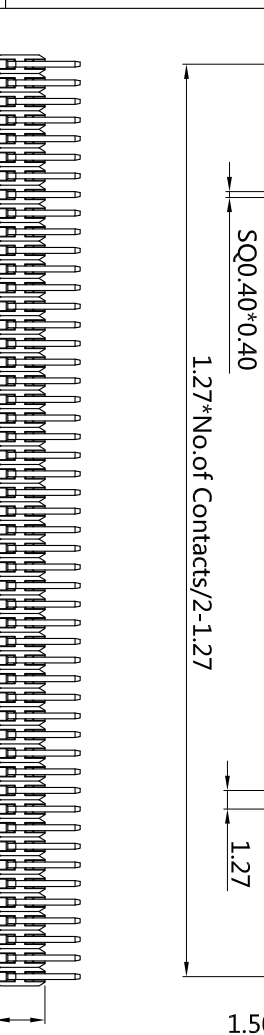
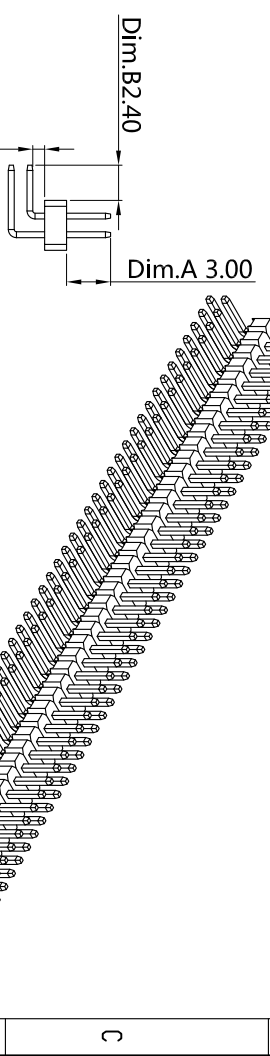
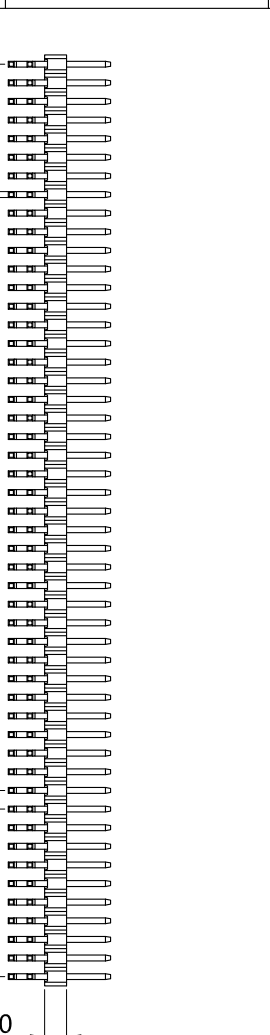


1 2 3 4 5 6 7 8

A



6 Current Rating: 1 Amps  
 Insulator Resistance: 1000 Megohms min  
 Dielectric Withstanding: AC 300V  
 Contact Resistance: 20mΩ MAX  
 Operation Temperature: -40~+105°C  
 Max processing temp: 230°C for 60seconds  
 Max processing temp: 260°C for 10seconds  
 Contact Material: Brass  
 Insulator material: Standard: Polyester, UL 94V-0  
 Standard: PA6T  
 Finish: Tin Gold Plated  
 Standard: Gold Flash all over



Recommended P.C. Board  
SMD Layout

(RoHS Compliant) **H3 X 15 - 2 XX R0 BK X 000 X**

1. Insulator material: 5. Contact Plated:  
 N=PA6T T=Matte Tin over Nickel I=Gold 1μ"  
 L=LCP P=PA9T W=Matte Tin over nickel E=Gold 5μ"  
 Circuits:2-50 PIN Y=Bright Tin over Nickel G=Gold 10μ"  
 3. Tail Style: F=Gold Flash, Matte Tin 100μ" J=Gold 10μ"  
 R0=Right angle A=Gold 3μ" L=Gold 15μ"  
 Color: B=Gold 3μ" M=Gold 15μ"  
 D=Gold 5μ" U=Gold 30μ" V=Gold 30μ"  
 Matte Tin 100μ"

6.Special Options  
 7. Packing:  
 A=Bag B=Tube  
 D=Small box E=Cap+Reel

<p>东莞市震升电子有限公司 DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD</p>		PART NO.		H3X15-2XXR0BKX000X		X		.XX		.XXX	
BOM		DRAWING NO		ZS-00058-P		EDITION:A1		ITEM: H3		SCALE:1:1	
1:H3N15-150BKHOCl		DRAWN BY		Deng jin quan		2021-12-25		UNIT:M:M			
2:SQ0.4-8.7/11.2-X-Cl2		APPROVAL BY		Chen xiao guang		2021-12-27					
3:											

F

1 2 3 4 5 6 7 8